

ZTE中兴



This user manual is for MG2636 module



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Preface

Summary

This user manual is for MG2636 modules. It takes MG2636 modules for example to give the reference to the relevant hardware and mechanical design. This manual could instruct the users how to quickly and conveniently design different kinds of wireless terminals based on this type of module.

Target Readers

- System designing engineers
- Mechanical engineers
- Hardware engineers
- Software engineers
- Test engineers

Brief Introduction

This manual contains 4 chapters. See the table below:

The manda contains Tenapte				
Chapter	Contents			
1. General Description	Introduces MG2636 module's basic functions, principle diagrams,			
	application diagrams, the relevant documents for reference.			
2. PIN Definitions	Introduces MG2636 module's PIN name and functions.			
3. Description of Hardware	Introduces the design of the hardware interface on each part of MG2636			
Interface	modules.			
4. Mechanical Design	Introduces MG2636 module's appearance diagram and assembly			
	diagram.			

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1 General Description

This user manual is for MG2636 modules. Refer to this manual to make your hardware and mechanical design fully compatible with GSM/GPRS applications, except for antenna design. With the function of voice, SMS and data service, ZTE MG2636 module can be used for data transmission, wireless POS, security and surveillance, lottery terminal, intelligent metering system, wireless fax, small switch, tobacco communication system, campus communications, wireless AD, wireless media, medical surveillance, direct discharge station surveillance, railway terminals, intelligent home appliances and vehicle-mounted monitoring, etc.

This manual describes MG2636 module's logic structure, hardware interface & major functions, and provides references to the hardware and mechanical design.

1.1 Functions

Table 1-1 Table of functions

lable 1-1 lable of functions				
Basic functions	Descriptions			
Work frequency	EGSM900 Transmit (uplink: MS→BTS): 880~915 MHz			
(Dual band:	Receive (downlink: BTS→MS): 925~960 MHz			
EGSM9000/	DCS1800	Transmit (uplink: MS→BTS) : 1710~1785 MHz		
DCS1800)		Receive (downlink: BTS→MS): 1805~1880 MHz		
Max. Tx power	EGSM900: Class4 (2W)	31~35dBm (typical value: 33 dBm)		
	DCS1800: Class1 (1W)	28~32dBm (typical value: 30 dBm)		
Rx. Sensitivity	<-106 dBm			
Work	Normal work temperature:	: -20°C~+55°C		
temperature	Expanded work temperatu	ure: -30°C~+70°C		
	Storage temperature: -40°	C~+85°C		
Voltage	3.4V~4.7V (recommended	d value: 3.8V)		
Power	Power off current: 50uA			
consumption	Standby average current:	2.5mA		
(current)	GPRS Class10 (MAX): 300mA			
UART0 interface (8-wire hardware flow control, max. data rate: 92°				
	support download and data communication			
Application	cation UART1 interface (4-wire hardware flow control, max. data rate: 921600bps)			
interface (50Pin	Standard SIM card interface	ce (1.8V/3.0V), support R-UIM		
B2B connector) 2CH analog audio I/O interface, using differential signals				
	1CH serial digital audio i	nterface, using PCM encoding analog audio signal to		
digital signal				
Power management interface (including power interface and charge into Network status indication interface (different network status indicated				
				different flashing modes)
	Power on-off interface (ex	sternally power on/off the module through the interface		
	(indirect switch power))			
Reset interface (externally reset the module through the interface)				



Antenna interface
Protocol Support GSM/GPRS Phase2/2+ AT command Refer to 《AT Command Set User Manual of ZTE Corporation's MG2636 modules》 Voice Support FR, EFR, HR and AMR audio encoding Support hands-free talk, echo suppression function Support MO and MT Support Point to Point and cell broadcast Support TEXT and PDU GPRS CLASS 10 Encoding method: CS 1,CS 2,CS 3,CS 4 Max. downlink transmitting rate: 85.6 kbps GPRS Max. uplink transmitting rate: 42.8 kbps
AT command Refer to 《AT Command Set User Manual of ZTE Corporation's MG2636 modules》 Voice Support FR, EFR, HR and AMR audio encoding Support hands-free talk, echo suppression function Support MO and MT SMS Support Point to Point and cell broadcast Support TEXT and PDU GPRS CLASS 10 Encoding method: CS 1,CS 2,CS 3,CS 4 Max. downlink transmitting rate: 85.6 kbps GPRS Max. uplink transmitting rate: 42.8 kbps
Voice Support FR, EFR, HR and AMR audio encoding Support hands-free talk, echo suppression function Support MO and MT Support Point to Point and cell broadcast Support TEXT and PDU GPRS CLASS 10 Encoding method: CS 1,CS 2,CS 3,CS 4 Max. downlink transmitting rate: 85.6 kbps GPRS Max. uplink transmitting rate: 42.8 kbps
Support hands-free talk, echo suppression function Support MO and MT SMS Support Point to Point and cell broadcast Support TEXT and PDU GPRS CLASS 10 Encoding method: CS 1,CS 2,CS 3,CS 4 Max. downlink transmitting rate: 85.6 kbps GPRS Max. uplink transmitting rate: 42.8 kbps
Support MO and MT Support Point to Point and cell broadcast Support TEXT and PDU GPRS CLASS 10 Encoding method: CS 1,CS 2,CS 3,CS 4 Max. downlink transmitting rate: 85.6 kbps GPRS Max. uplink transmitting rate: 42.8 kbps
SMS Support Point to Point and cell broadcast Support TEXT and PDU GPRS CLASS 10 Encoding method: CS 1,CS 2,CS 3,CS 4 Max. downlink transmitting rate: 85.6 kbps GPRS Max. uplink transmitting rate: 42.8 kbps
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Max. downlink transmitting rate: 85.6 kbps GPRS Max. uplink transmitting rate: 42.8 kbps
GPRS Max. uplink transmitting rate: 42.8 kbps
max. apimix transmitting rate. 12.6 kbpc
Cuppert DDCCH and virtual online:
Support PBCCH and virtual online;
Embedded TCP/IP protocol: support multi-link, provides ACK and large capacity
cache;
Circuit domain Support CSD data service, max. data rate: 14.4Kbit/s
data service Support USSD
Supplementary Incoming caller ID presentation, call forwarding, call held, call waiting, etc.
service
Physical Dimensions: 35±0.10 x 32.5±0.10 x 3.85±0.20 mm
features Weight: 7.0 g
ROHS Meet the requirements of ROHS
environment
protection
CE certification Meet the requirements of CE

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1.2 Principle Diagrams

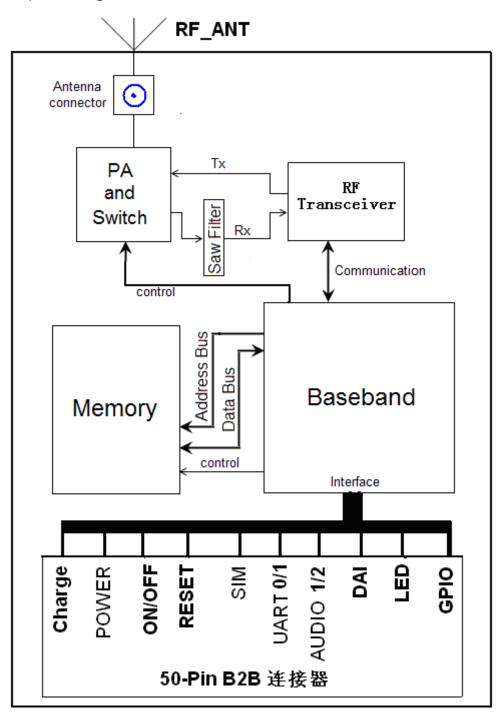


Figure 1-1 Module's principle diagrams



1.3 Application Diagrams

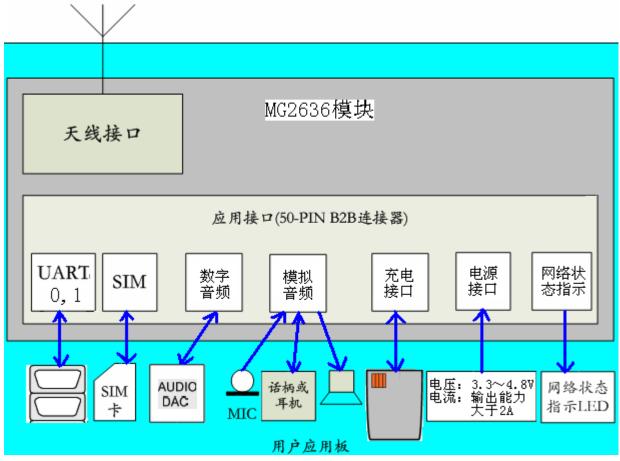


Figure 1-2 Module's application diagrams



1.4 Relevant Documents

- 《AT Command Manual for ZTE Corporation's MG2636 Modules》
- 《ZTE Corporation GPRS modules FAQ》
- 《Wireless modules' Test References》

1.5 Acronyms

Table 1-2 Table of Acronyms

	Table 1-2 Table Of Actor	191110	
Α			
ADC	Analog-Digital Converter	模数转换	
AFC	Automatic Frequency Control	自动频率控制	
AGC	Automatic Gain Control	自动增益控制	
ARFCN	Absolute Radio Frequency Channel	绝对射频信道号	
	Number		
ARP	Antenna Reference Point	天线参考点	
ASIC	Application Specific Integrated Circuit	专用集成电路	
В			
BER	Bit Error Rate	比特误码率	
BTS	Base Transceiver Station	基站收发信台	
С			
CDMA	Code Division Multiple Access	码分多址	
CDG	CDMA Development Group	CDMA 发展组织	
CS	Coding Scheme	译码图案	
CSD	Circuit Switched Data	电路交换数据	
CPU	Central Processing Unit	中央处理单元	
D			
DAI Digital Audio interface		数字音频接口	
DAC	Digital-to-Analog Converter	数模转换	
DCE	Data Communication Equipment	数据通讯设备	
DSP	Digital Signal Processor	数字信号处理	
DTE	Data Terminal Equipment	数据终端设备	
DTMF	Dual Tone Multi-Frequency	双音多频	
DTR	Data Terminal Ready	数据终端准备好	
E			
EDGE	Enhanced Data Rate for GSM Evolution	提高数据速率的 GSM 演进技术	
EFR	Enhanced Full Rate	增强型全速率	
EGSM	Enhanced GSM	增强型 GSM	



EMC	Electromagnetic Compatibility	电磁兼容	
EMI	Electro Magnetic Interference	电磁干扰	
ESD	Electronic Static Discharge	静电放电	
ETS	European Telecommunication Standard	欧洲通信标准	
210	European relecommunication etanicate	CALIFICATION TO THE PARTY OF TH	
F	<u> </u>	I	
FDMA	Frequency Division Multiple Access	频分多址	
FR	Full Rate	全速率	
G		1	
GPRS	General Packet Radio Service	通用分组无线业务	
GSM	Global Standard for Mobile	全球移动通讯系统	
	Communications		
Н			
HR	Half Rate	半速率	
1	,	T.	
IC	Integrated Circuit	集成电路	
IMEI	International Mobile Equipment Identity	国际移动设备标识	
ISO	International Standards Organization	国际标准化组织	
ITU	International Telecommunications Union	国际电信联盟	
L			
LCD	Liquid Crystal Display	液晶显示器	
LED	Light Emitting Diode	发光二极管	
M	T	The fill to start V -	
MCU	Machine Control Unit	机器控制单元	
MMI	Man Machine Interface	人机交互接口/人机界面	
MS	Mobile Station	移动台	
MTBF Mean Time Before Failure		平均故障间隔时间	
P		1	
PCB	Printed Circuit Board	印刷电路板	
PCL	Power Control Level	功率控制等级	
PCS	Personal Communication System	个人通讯系统	
PDU	Protocol Data Unit	协议数据单元	
PLL	Phase Locked Loop	锁相环	
PPP	Point-to-point protocol	点到点协议	
	The second process.	WINEAULDA SA	
R	1	1	
RAM	Random Access Memory	随机访问存储器	
RF	Radio Frequency	无线频率	
L	· ·	7 - 74771 I	



ROM	Dood only Momony	只读存储器	
DMO	Read-only Memory		
	Root Mean Square	均方根	
RTC	Real Time Clock	实时时钟	
S			
SIM	Subscriber Identification Module	用户识别卡	
SMS	Short Message Service	短消息服务	
SMT	Surface Mount Technology	表面安装技术	
SRAM	Static Random Access Memory	静态随机访问存储器	
Т			
TA	Terminal adapter	终端适配器	
TDMA	Time Division Multiple Access	时分多址	
TE Terminal Equipment also referred it as		终端设备,也指 DTE	
	DTE		
U			
UART Universal asynchronous		通用异步接收/发送器	
1	receiver-transmitter		
UIM	User Identifier Management	用户身份管理	
USB	Universal Serial Bus	通用串行总线	
USIM	Universal Subscriber Identity Module	用户识别模块	
V			
VSWR	Voltage Standing Wave Ratio	电压驻波比	
Z			
ZTE	ZTE Corporation	中兴通讯股份有限公司	

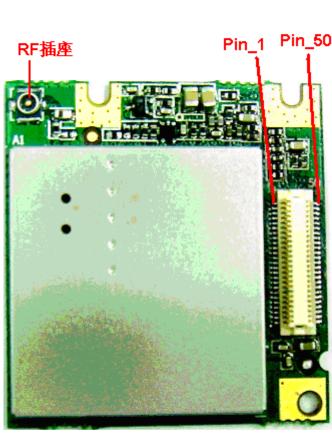


2 PIN Definitions

Adopting 50-Pin B2B connector interface, MG2636 module has 50 pins with the distance 0.5mm between the pins.

2.1 Module's PIN Diagram

Figure 2.1 Module's PIN Diagram



Ī	1	SIM-CLK	SPK2_N	50
Ī	2	SIM-UCC	SPK2_P	49
Ī	3	SIM-DATA	SPK1_P	48
İ	4	SIM-RST	SPK1_N	47
Ī	5	ISENSE	MIC2_N	46
Ī	6	SIM-GND	MIC2_P	45
Ī	7	DAIRXD	MIC1_P	44
Ī	8	DAISYNC	MIC1_N	43
Ī	9	DAICLK	AGND	42
İ	10	DAITXD	PWRKEY_N	41
Ī	11	DAIRST	SYSRST_N	40
Ī	12	BATT_TEMP	DCD0	39
Ī	13	SIG_LED	CTS1	38
Ī	14	RXD1	CTS0	37
Ī	15	RXD0	RTS1	36
İ	16	TXD1	DTR0	35
Ī	17	TXD0	RTS0	34
Ī	18	BAT_BACKUP	DSR0	33
Ī	19	CHRIN	RING0	32
Ī	20	GATEDRU	UDDIO	31
İ	21	GND	BATT+	30
İ	22	GND	BATT+	29
T	23	GND	BATT+	28
İ	24	GND	BATT+	27
t	25	GND	BATT+	26



2.2 50-Pin B2B Connector Interface Definitions

Table 2-1 50-Pin B2B Connector Interface Definitions

Functions	PIN No.	Definitions	I/O	Descriptions
1	SIM-CLK	0	SIM card clock	
2	SIM-VCC	0	SIM card power	Max. output current 20mA
3	SIM-DATA	I/O	SIM card data	,
4	SIM-RST	0	SIM card reset	
5	ISENSE	Al	Current inductor detect	
			current	
6	SIM-GND	Р	SIM card GND	SIM card's GND PIN and
				SIM-GND PIN must connect
				with the module's power GND.
7	DAIRXD	I	DAI: receive data	internal pull-down(51.1KΩ)
8	DAISYNC	0	DAI: frame SYNC	
9	DAICLK	0	DAI: clock	internal pull-down(51.1KΩ)
10	DAITXD	0	DAI: transmit data	
11	DAIRST	0	DAI: reset	internal pull-down(51.1KΩ)
12	BATT_TEMP	Al	Battery ID or battery	Analog input voltage range:
			temperature detection	0~2.8V
13	SIG_LED	0	Network signal LED	High level LED ON, need
				externally connect dynatron driver
14	RXD1	0	LIADT1 corresponding to	
14	RXDI	0	UART1 corresponding to DTE's RXD	internal pull-down(75KΩ)
15	RXD0	0	UART0 corresponding to DTE's RXD	internal pull-down(75KΩ)
16	TXD1	I	UART1 corresponding to	internal pull-down(75KΩ)
			DTE's TXD	, ,
17	TXD0	I	UART0 corresponding to	internal pull-down(75KΩ)
			DTE's TXD	
18	BAT_BACKUP	Р	Real-time clock (RTC)	Connect button battery or
			backup power	large capacitor. Input: 2.2~5V;
				max. output: 2.6~2.85V;under
				POWER DOWN mode, min.
				input: 1.3V.
19	CHRIN	Р	External charge power	4.2V~8V (recommended
			detection input	5.5V), external connect the
				charge power with the current
				no less than 800mA. This pin
				is just used as diction. And It
				will be hung out when not
				used.



20	GATEDRV	0	Battery charge control switch	Valid at low level
21	GND	Р	GND	
22	GND	Р	<u>-</u>	
23	GND	Р	-	
24	GND	P	<u>-</u>	
25	GND	P	<u>-</u>	
26	BATT+	P	Work current anode input	3.4V~4.7V (recommended
27	BATT+	P		3.8V), as the module
28	BATT+	Р	-	transmits with the max. power,
29	BATT+	<u>.</u> Р	-	the current will instantly reach
30	BATT+	P	-	1.6A. The min, value of
	D/(III	•		BATT+ voltage is no lower
				than 3.3V, and the current no
				lower than 2A.
31	VDDIO	0	Module output digital	Typical value: 2.85V(MIN:
			interface voltage	2.75V,MAX: 2.95V,MAX
				current: 150mA). There is
				voltage output only as the
				module is powered on. And It
				will be hung out when not
				used.
32	RING0	0	UART0 corresponding to	internal pull-down(75KΩ)
			DTE's RING	
33	DSR0	0	UART0 corresponding to	internal pull-down(75KΩ)
			DTE's DSR	
34	RTS0	I	UART0 corresponding to	internal pull-down(75KΩ)
			DTE's RTS	
35	DTR0	I	UART0 corresponding to	internal pull-down(75KΩ)
			DTE's DTR	
36	RTS1	I	UART1 corresponding to	internal pull-down(75KΩ)
			DTE's RTS	
37	CTS0	0	UART0 corresponding to	internal pull-down(75KΩ)
			DTE's CTS	
38	CTS1	0	UART1 corresponding to	internal pull-down(75KΩ)
			DTE's CTS	
39	DCD0	0	UART0 corresponding to	internal pull-down(75KΩ)
			DTE's DCD	
40	SYSRST_N	I	Module's reset	Valid at low level, need
				externally connect dynatron
				driver. It's recommended to
				parallel connect 0.1uF
				capacitor to GDN for ESD
				protection near 50-pin B2B
				connector.



41	PWRKEY N	I	Module's power on/off	Valid at low level, need
		-		externally connect dynatron
				driver.
40	AOND		OND	diver.
42	AGND	Р	GND	
43	MIC1_N	Al	1CH audio input cathode	Default audio I/O is the first
44	MIC1_P	Al	1CH audio input anode	channel. Usually the first
45	MIC2_P	Al	2CH audio input anode	channel is used for the
				receiver and the second
				channel used for headset or
				hands-free.
46	MIC2_N	2CH		
	Al	audio		
		input		
		cathode		
47	SPK1_N	AO	1CH audio output cathode	
48	SPK1_P	AO	1CH audio output anode	
49	SPK2_P	AO	2CH audio output	
			anode(right ear)	
50	SPK2_N	AO	2CH audio output	
			cathode(left ear)	

Note: 1) I—representing digital signal input PIN; O—representing digital signal output PIN; AI—representing analog signal input PIN; AO—representing analog signal input PIN;; P—representing power PIN;

2) UART0 and UART1 are named by DCE PIN signals.

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3 Decription of Hardware Interfaces

3.1 Summary

This chapter introduces MG2636 module's each function & its operation descriptions, and provides the designing sample.

- Power interface
- Charge interface
- Power on/off interface
- Reset interface
- UART interface (2CH)
- SIM Card
- Audio Interface (2CH analog audio interface)
- DAI interface (1CH digital audio interface)
- Network signal indication interface
- Antenna interface
- Other

3.2 Power and Reset

3.2.1 Power

MG2636 GSM module requires VBAT and real-time clock BAT_BACKUP to work normally. For details, please see the following table 3-1 Power PIN Interface Definitions.

Table 3-1 Power PIN Interface Definitions

PIN No.	Signal Name	I/O	Descriptions of	Remarks
			Functions	
21~25	GND	Р	GND	
26~30	BATT+	Р	Work Power	3.4V~4.7V (recommended 3.8V), as
			Anode Input	the module transmits with the max.
				power, the current will instantly reach
				1.6A. The min, value of BATT+
				voltage is no lower than 3.3V, and the
				current no lower than 2A.
18	BAT_BACKUP	Р	Real-time	Connect button battery or large
			Clock (RTC)	capacitor. Input: 2.2~5V; max. output:
			Backup	2.6~2.85V;under POWER DOWN
				mode, min. input: 1.3V.

MG2636 module requires external power supply and the power supply voltage ranges from $3.4V\sim4.7V$ (typical value 3.8V). The external power supplies the power to the module through B2B connector's VBAT PIN. As the module transmits with the max. power, the current will instantly reach



about 1.6A and VBAT voltage will fall down, however the min, value of BATT+ voltage must be no lower than 3.4V. The external power can provide the current required at MAX. Tx. Power, and it's recommended to use LDO or switch power with the output current larger than 2A and a 100uF energy storage capacitor is parallel connected at the power end of the module. In order to guarantee the supply of current, use 5PIN on the power loop as the power supply and GND return current respectively.

BAT_BACKUP is real-time backup input interface of MG2636 GSM module. As VBAT is ON, real-time clock could supply power through VBAT; as VBAT is not ON, BAT_BACKUP will supply the backup power for real-time clock. BAT_BACKUP can use the battery to supply the power and the battery voltage ranges from 2.8~5V. If the backup battery is not used, it could externally connect the capacitor. The value of capacitor decides the clock's duration as VBAT is not ON. The calculation formula is as below: t=C/15; t represents the real-time clock's duration (unit: s), and C represents the value of capacitor (unit: uF). The required current is about 15uA as MG2636 modules maintains the real-time clock function upon the power cut-off. The following figure is the charge reference circuit of RTC backup battery or capacitor.

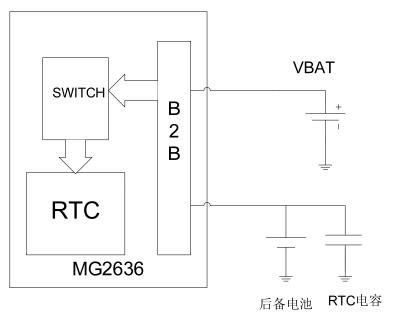


Figure 3-1 MG2636 Module's RTC Backup Battery/Capacitor Reference Circuit AS VBAT> backup battery, it can charge the backup battery, and the charging cut-off voltage is 3.3V; as the battery does not work, RTC work current is 15uA.

3.2.2 Power On/Off

The module is under power-off status after it's normally powered on. To turn on the module, provide a 2000-3000mS low level pulse to PWRKEY_N pin when the module is OFF.

In Data mode, if you connect VCHG to VPH_PWR, the module will be automatically powered on.

It's specially noted that PWRKEY_N is valid at low level, which is required externally to connect dynatron driver. It's recommended to parallel connect 0.1uF capacitor to GDN for ESD protection near 50-pin B2B connector



3.2.3 **Reset**

SYSRST_N PIN is used to reset the module's main chip, and SYSRST_N signal needs to be pulled down 200ms to reset the module. Likewise, this pin is required externally to connect dynatron driver and parallel connect 0.1uF capacitor to GDN to prevent SYSRST_N signal from external interference. And it's noted that the wiring of 50pin connector must be as short as possible.

3.3 COM Port

The module provides 1CH serial interface, supports 8-wire serial BUS interface or 4-wire serial BUS interface or 2-wire serial interface. The module communicates with the external devices and inputs AT commands through UART interface. UART supports programmable data width, programmable data stop bit, programmable parity check or no check, and UART port supports from 300bit/s to 921.6kbit/s baud rate. The default baud rate is 115200bit/s and it supports baud rate storage upon power drop.

MG2636 module can directly connect the same signal name of DTE devices. Please see table 3-2 module UART signal names and figure 3-2 for the connection diagram between the module and DTE device.

Table 3-2 MG2636 module UART	external	device's signal	names and functions
------------------------------	----------	-----------------	---------------------

PIN No.	Signal Name	I/O	Descriptions of Functions	Remarks
32	RING0	0	UART0 port, corresponding	Internal pull-up(75KΩ)
			to DTE's RING port	
33	DSR0	0	UART0 port, corresponding	Internal pull-up(75KΩ)
			to DTE's DSR port	
34	RTS0	I	UART0 port, corresponding	Internal pull-up(75KΩ)
			to DTE's RTS port	
35	DTR0	I	UART0 port, corresponding	Internal pull-up(75KΩ)
			to DTE's DTR port	
36	RTS1	1	UART1 port, corresponding	Internal pull-up(75KΩ)
			to DTE's RTS port	
37	CTS0	0	UART0 port, corresponding	Internal pull-up 75KΩ)
			to DTE's CTS port	
38	CTS1	0	UART1 port, corresponding	Internal pull-up(75KΩ)
			to DTE's CTS port	
39	DCD0	0	UART0 port, corresponding	Internal pull-up(75KΩ)
			to DTE's DCD port	



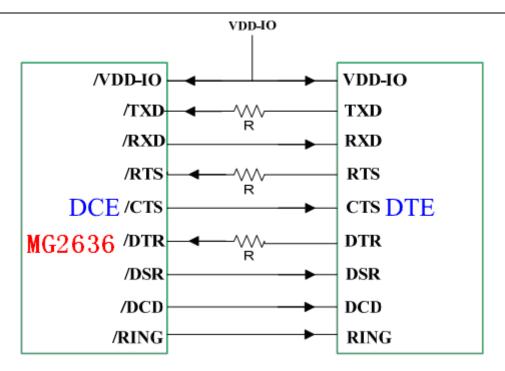


Figure 3-2 MG2636 module external DTE device's circuit connection diagram

MG2636 module can communicate with RXD and TXD of single chip microcomputer to compose the simplest 2-line mode. It's noted that MG2636 module's PIN level typical value is 2.8V, and interface level range $2.4V\sim3.1V$.

Likewise, the module can also communicate with the standard RS232 device. Due to the different interface level, 232 chip must be added for level conversion, e.g., use MAX3232 for 2-wire serial port and use MAX3238 for 8-wire serial port. The connection is the same as DTE device above.

3.4 SIM Card Interface

The module supports 1.8V/3V UIM card, and there are 4 pins at the terminal of the card. VREG_RUIM is used to supply the UIM card. It's strongly recommended to add ESD to protect the UIM card in hostile environments. FV2 in figure 4-4 is ESD protection device:

MG2636 module baseband processor integrates SIM card interface conforming to ISO 7816-3 standard, and it's compatible with SIM card with two voltages 1.8V/3.0V and reserves SIM card interface signal on B2B connector.

Users should note that SIM card's electrical interface definitions are the same as SIM card socket's definitions. See table 3-3 for MG2636 module's B2B connector's interface definitions.

PIN No.	Signal Name	I/O	Descriptions of	Remarks
			Functions	
1	SIM-CLK	0	SIM card clock	
2	SIM-VCC	0	SIM card power	Max. output current
				20mA
3	SIM-DATA	I/O	SIM card data	
4	SIM-RST	0	SIM card reset	
6	SIM-GND	Р	SIM card GND	SIM card's GND PIN
				and SIM-GND PIN must
				connect with the

Table 3-3 MG2636 module's SIM card signal



module's power GND.

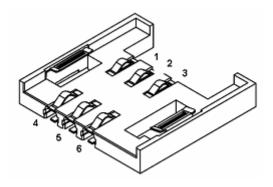


Figure 3-3 Standard SIM card PIN Definitions

As shown in figure 3-4, the module connects the external SIM card and SIM-VPP could directly connect SIM-VCC. 33 ohm resistor on 3 wires has been parallel connected with the capacitor to guarantee the compatibility of SIM card with different electrical performances; meantime it can also meet the requirements of EMC test standards.

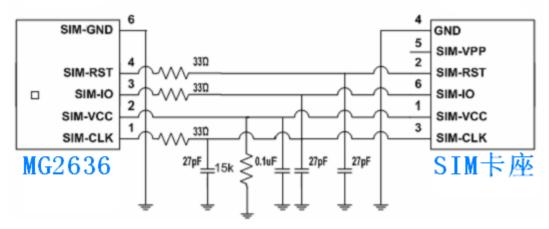


Figure 3-4 Connection Diagram of MG2636 module and external SIM card

Besides, since SIM card design should meet the requirements of ESD electrical performances to avoid the damage of SIM card, it's recommended to add TVS component on 4-CH SIM card signal, meantime, the signal wire need first pass TVS component and enter the module's baseband processor to avoid the damage of module.

3.5 Audio Interface

MG2636 GSM module supports 2CH audio signal input/output. When it's used for hand held devices, the hand held MIC, hand held receiver or hands-free speaker, headset MIC, headset receiver could be divided. See table 3-4 for the audio interface signals.

Table 6 4 MG2020 Module 8 dadio impat digitale					
PIN No.	Signal Name	I/O	Descriptions of Functions	Remarks	
43	MIC1_N	Al	1CH audio input cathode	!st channel is the	
44	MIC1_P	Al	1CH audio input anode	default audio	
45	MIC2_P	Al	2CH audio input anode	input/output. Usually	
46	MIC2_N	Al	2CH audio input cathode	1 st channel used for	
47	SPK1_N	AO	1CH audio output cathode	receiver, 2 nd	
48	SPK1_P	AO	1CH audio output anode	channel used for	

Table 3-4 MG2326 module's audio input signals



49	SPK2_P	AO	2CH audio output anode	headset	or
			(right ear)	hands-free.	
50	SPK2_N	AO	2CH audio output anode (left		
			ear)		

3.5.1 Microphone

The two microphone interfaces MIC1 and MIC2 are both differential interfaces, which could also be used for single-end input. It's recommended to use differential mode and meet the requirements of differential signals during the wiring layout and the wiring must be as short as possible to reduce the noises. These two inputs are coupled in AC domain and added a 1.8V offset voltage inside, and they should directly connect with the microphone.

ON the circuit design, add 33pF filter capacitor to the audio signal wire to reduce the interferences caused by the external antenna; meantime add TVS components accordingly.

3.5.2 Receiver

The receiver interfaces are SPK_1 and SPK_2. SPK_1 is differential interface with 32Ω resistance; SPK_2 is the single-end interface with 32Ω resistance. Due to the differences between SPK_1 and SPK_2, SPK_1 is usually used as hand hold device's Receiver, and SPK_2 is used for headset's left/right ears.

Note: Differential design of audio signals could suppress the noise, and the PCB wiring must be as short as possible. The differential signals must be kept far away from the power, RF and antenna circuit.

3.6 DAI (Digital Audio Interface)

DAI digital audio interface adopts PCM encoding from analog signal to digital signal, which could connect with devices for digital audio communications, such as Bluetooth device, and it is convenient for users to develop peripheral audio communicating system.

PIN No. Signal Name I/O Descriptions of Remarks **Functions** 7 **DAIRXD** DAI: Rx data Internal pull-down $(51.1K\Omega)$ 8 DAISYNC 0 DAI: frame SYNC **DAICLK** DAI: clock Internal pull-down $(51.1K\Omega)$ 10 **DAITXD** DAI: Tx data 0 11 **DAIRST** 0 DAI: reset Internal pull-down $(51.1K\Omega)$

Table 3-5 MG2636 module DAI



3.7 Network Status LED Interface

MG2636 GSM module provides a network status LED interface (SIG_LED), which outputs pulse signal to control the blinking frequency of LED and indicate different network status through the definitions of LED's blinking modes. For details, please refer to table 3-6.

SIG_LED PIN Output Status	Work or Network Status			
Output high level	Module startup			
Continue high level	Module calling			
Continue low level	Deep sleep			
Period 1s, high level output 0.1s	No SIM card, not enter PIN or searching			
	network			
Period 3s, high level output 0.1s	Registered to network, IDLE			
Period 0.125s, high level output 0.1s	GPRS data transmitting			

Table 3-6 MG2636 module's network status definitions

SIG_LED PIN output status is defined according to the software protocol, and users could judge the module's work status according to SIG_LED status.

SIG_LED PIN is common I/O port, which can't directly drive LED, and it needs to work with dynatron. For detailed circuit, please see figure 3-5.

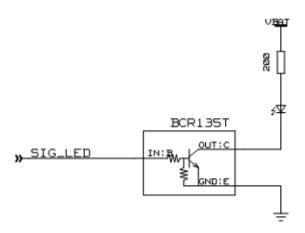


Figure 3-5 SIG_LED driver LED reference circuit

3.8 Antenna Interface

The module provides two kinds of antenna interface:

- PCB welding pad
- Antenna test socket

PCB welding pad adopts 50Ω RF shield cable to connect the module and the antenna, in order to reduce the cost. However, this method can not completely shield the electromagnets, which might have slight influence on RF signal quality. Please note that there should not be strong radiation near the welding pad. Meantime, during the welding, make sure the core of RF shield cable must connect with RF welding pad, and RF shield cable's shield metal mask must be welded to the module's GND. During the welding, the GND must be welding securely, otherwise, the core is easily broken due to the shaking of shield cable. See figure 3-6 for RF welding pad antenna.





Figure 3-6 MG2636 module RF welding pad antenna

The antenna test socket is used for the module's calibration and test. The contact resistance is small and the shielding is good. An exclusive 50Ω socket to SMA connection cable is used to connect the module and the antenna. The antenna test socket's resistance is 50Ω . The antenna test socket's part number is MM9329-2700B. Please refer the socket manufacturer's manual to select the relevant antenna to connect the plug and module.



Figure 3-7 MG2636 module's RF test socket



4 Mechanical Design

4.1 Appearance Diagram

MG2636 module's appearance

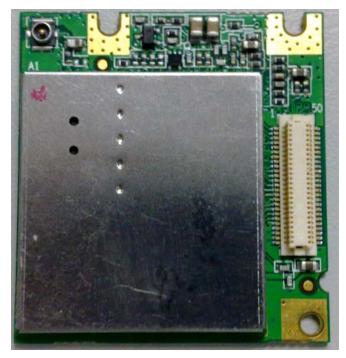


Figure 3-8 MG2636 module's appearance

Dimensions (LxWxH) : 35±0.10 x 32.5±0.10 x 3.85±0.20 mm

Weight: 7g

4.2 Assembly Diagrams



4.2.1 MG2636 Module's Assembly Diagram Dimensions

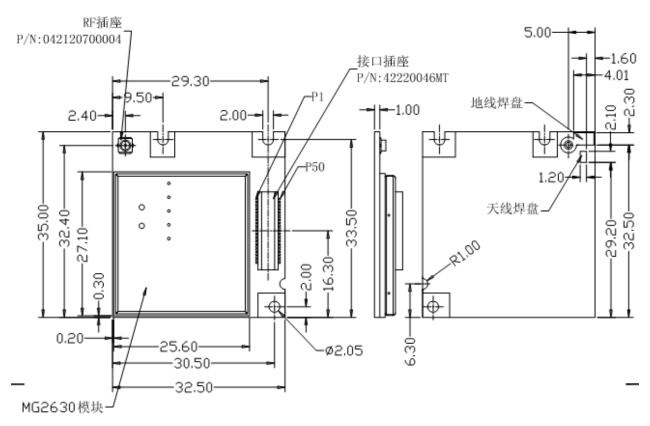


Figure 4-2 MG2636 Module's Assembly Diagram

Technical requirements: 1) *Dimensions. Representing check the dimensions;

2) tolerances +-0.1mm.

4.2.2 B2B Connector Socket

In order to meet the requirements of electrical performances of B2B connector, users should select the proper connector. The part number of the connector for MG2636 module is DF12C(3.0)-50DS-0.5V(81). Users can refer to DF12C(3.0)-50DS-0.5V(81) specifications to search for the matched connector.

Remarks: DF12C (3.0)-50DS-0.5V (81) is Shenzhen JieRong Technology Co., Ltd.



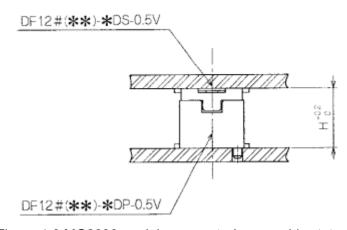


Figure 4-3 MG2636 module connector's assembly status

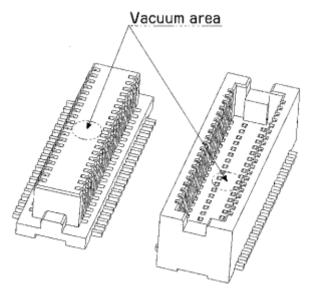


Figure 4-4 MG2636 module connector's relevant appearance diagram